



12500 TI Boulevard, MS 8640, Dallas, Texas 75243

PCN# 20080922000
Datasheet Errata for Device Type TS3DV520E_A
Information Only

Dear Customer:

This is an information-only announcement of a change to a device that is currently offered by Texas Instruments.

The changes discussed within this PCN are for your information only. Please see the attachment details for the planned implementation date.

This notification period is per TI's standard process. Any negotiated alternative change requirements will be provided via the customer's defined process. Customers with previously negotiated, special requirements will be handled separately. Any inquiries should be directed to your local Field Sales Representative.

For questions regarding this notice, contact your local Field Sales Representative or the PCN Manager (PCN_ww_admin_team@list.ti.com).

Sincerely,

PCN Team
SC Business Services
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PCN Number:	20080922000	PCN Date:	10/13/2008
Title:	Datasheet Errata for Device Type TS3DV520E_A		
Customer Contact:	Linda K Miles	Phone:	903-868-7638
Dept:	Standard Linear and Logic		
Proposed 1st Ship Date:	10/13/2008	Estimated Sample Availability:	10/13/2008
Change Type:			
<input type="checkbox"/>	Assembly Site	<input type="checkbox"/>	Assembly Process
<input type="checkbox"/>	Design	<input checked="" type="checkbox"/>	Electrical Specification
<input type="checkbox"/>	Test Site	<input type="checkbox"/>	Packing/Shipping/Labeling
<input type="checkbox"/>	Wafer Bump Site	<input type="checkbox"/>	Wafer Bump Material
<input type="checkbox"/>	Wafer Fab Site	<input type="checkbox"/>	Wafer Fab Materials
<input type="checkbox"/>		<input type="checkbox"/>	Assembly Materials
<input type="checkbox"/>		<input type="checkbox"/>	Mechanical Specification
<input type="checkbox"/>		<input type="checkbox"/>	Test Process
<input type="checkbox"/>		<input type="checkbox"/>	Wafer Bump Process
<input type="checkbox"/>		<input type="checkbox"/>	Wafer Fab Process

PCN Details

Description of Change:

Texas Instruments' Standard Linear and Logic Group is correcting the datasheet for TS3DV520E; there are several conflicts of spec at the areas of the followings:

- Removing the following sentences from the DESCRIPTION/ORDERING INFORMATION section.
 - o This device is specified for partial-power-down applications using loff. The loff feature ensures that damaging current will not backflow through the device when it is powered down. The device has isolation during power off. ---- (this part remains as is.) ----, even in the power-down mode(VCC=0V).
- Add the following footnotes for each package drawings from page #2.
 - o For the RHU package, the Exposed Center Pad, if used, must be connect to GND or left electrically open.
 - o For the RUA package, the Exposed Center Pad, must be connected to GND for proper device operation.
- ABSOLUTE MAX RATINGS table on page 4. Change the values at V_I/O(Switch I/O voltage range), I_IK(Control input clamp current), I_I/OK(I/O port clamp current).

Change From

	MIN	MAX	UNIT
V_I/O Switch I/O voltage range	-0.5	7	V
I_IK Control input clamp current Vin < 0		-50	mA
I_I/OK I/O port clamp current Vi/o < 0		-50	mA

Change To

	MIN	MAX	UNIT
V_I/O Switch I/O voltage range	-0.5	VCC+0.5	V
I_IK Control input clamp current Vin < 0, or Vin > VCC	-50	+50	mA
I_I/OK I/O port clamp current Vi/o < 0, or Vi/o > VCC	-50	+50	mA

- RECOMMENDEDOPERATINGCONDITIONS table on page 4. Change the values at V_I/O (Input/output voltage)

Change From

	MIN	MAX	UNIT
V_I/O Input/output voltage	0	5.5	V

Change To

	MIN	MAX	UNIT
V_I/O Input/output voltage	0	VCC	V

- Operating characteristics graph at the page #6, Figure 4 has to be renamed as "Figure 4. r_{on} vs. V_{com} ($V_{cc}=3.6V$)". And the plot has to be stopped at 3.6V.

Change From

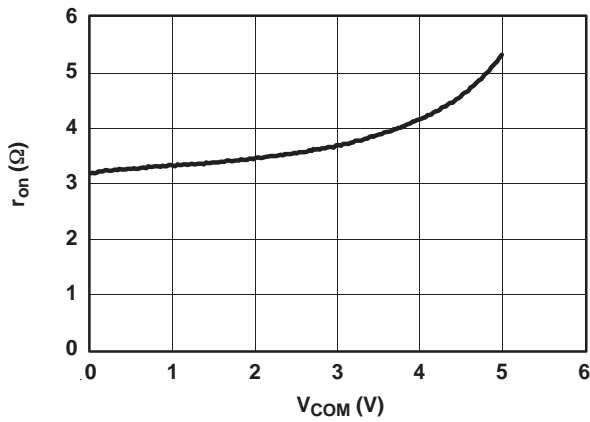


Figure 4. r_{on} and V_o vs V_1

Change To

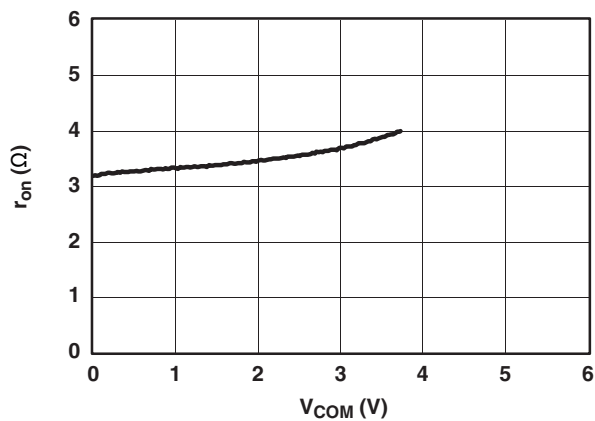


Figure 4. r_{on} V_{com} ($V_{cc}=3.6V$)

Literature Number

Device Type	Current Literature #	New Literature #
TS3DV520E	SCDS240	SCDS240A

Reason for Change:

This modification will correct the datasheet.

Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):

Texas Instruments does not anticipate a negative impact on fit, form, function, quality or reliability.

Changes to product identification resulting from this PCN:

There are no changes to product identification.

Product Affected:

TS3DV520ERHUR
TS3DV520ERHURG4
TS3DV520ERUAR

For questions regarding this notice, e-mails can be sent to the regional contacts shown below or your local Field Sales Representative.

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